

AM4417PT-1-PF-VB Datasheet P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
- 60	0.0250 at V _{GS} = - 10 V	- 10	76 nC			
- 60	0.0280 at V _{GS} = - 4.5 V	- 9	70110			

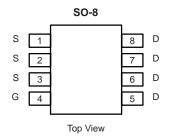
FEATURES

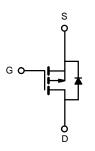
- Trench Power MOSFET
- 100 % UIS Tested

APPLICATIONS

Load Switch







P-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 60	.,	
Gate-Source Voltage		V_{GS}	± 20	V
	T _C = 25 °C		- 10 ^a	
Continuous Proin Current (T = 150 °C)	T _C = 70 °C		- 9	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	8 ^b	^
	T _A = 70 °C		- 8 ^b	A
Pulsed Drain Current		I _{DM}	- 50	
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	- 45	
Single Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	101	mJ
Continuous Source-Drain Diode Current	T _C = 25 °C	1	69 ^a	A
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S —	2.1 ^b	A
	T _C = 25 °C		104.2 ^a	
Mariana Dama Dissipation	T _C = 70 °C		66.7 ^a	10/
Maximum Power Dissipation	T _A = 25 °C	P _D	3.1 ^b	W
	T _A = 70 °C		2 ^b	
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	33	40	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.98	1.2	C/VV	

Notes:

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	V_{DS}/T_J $I_D = -250 \mu\text{A}$		68		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 _D = - 250 μΛ		- 5.2		liiv/ C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 1		- 3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zana Cata Valta da Busin Comunit	,	V _{DS} = - 60 V, V _{GS} = 0 V			- 1	μА	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 55 °C	- 10		- 10		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 12			Α	
	В	V _{GS} = - 10 V, I _D = - 5 A	0.0250				
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 5A		0.0280		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 10 A	20			S	
Dynamic ^b	1			'		·	
Input Capacitance	C _{iss}			3500		pF	
Output Capacitance	C _{oss}	V _{DS} = - 25 V, V _{GS} = 0 V, f = 1 MHz		390			
Reverse Transfer Capacitance	C _{rss}			290			
T. 10 . 0	Qg	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -55 \text{ A}$		76	115		
Total Gate Charge				38	60	nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -55 \text{ A}$		16			
Gate-Drain Charge	Q_{gd}			19			
Gate Resistance	R _g	f = 1 MHz		5.2		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	$V_{DD} = -2 \text{ V}, R_L = 2 \Omega$		7	15	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω		70	110		
Fall Time	t _f			40	60		
Drain-Source Body Diode Characteristic	s			<u>'</u>		l	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 9	Α	
Pulse Diode Forward Current ^a	I _{SM}				- 15		
Body Diode Voltage	V_{SD}	I _S = - 30 A		- 1	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			45	68	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = -50 A, di/dt = 100 A/μs, T _J = 25 °C		59	120	nC	
Reverse Recovery Fall Time	t _a			29			
Reverse Recovery Rise Time	t _b			16		ns	

Notes:

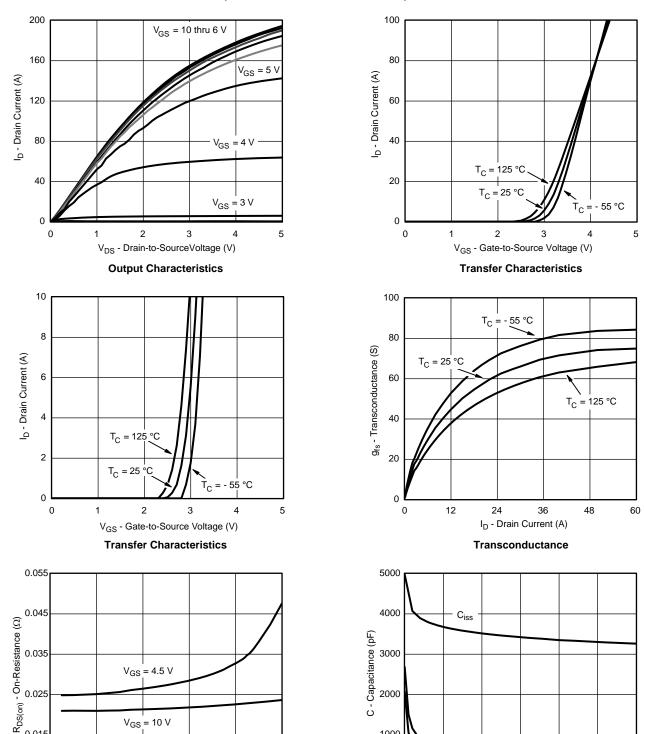
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



1000

0

0

 $\mathsf{C}_{\mathsf{rss}}$

10

30

Capacitance

V_{DS} - Drain-to-Source Voltage (V)

40

50

60

On-Resistance vs. Drain Current

I_D - Drain Current (A)

60

40

0.015

0.005

0

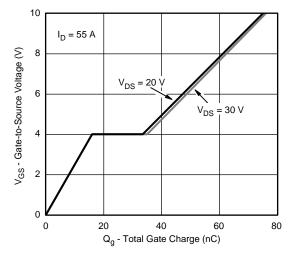
20

80

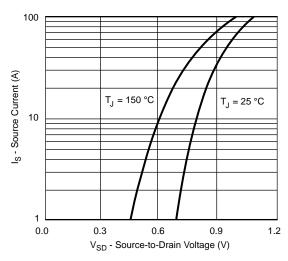
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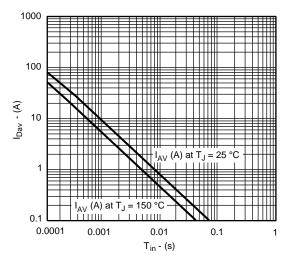
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



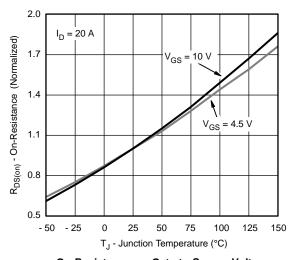
Gate Charge



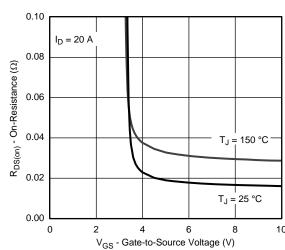
Source-Drain Diode Forward Voltage



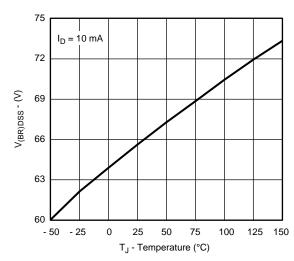
Single Pulse Avalanche Current Capability vs. Time



On-Resistance vs. Gate-to-Source Voltage



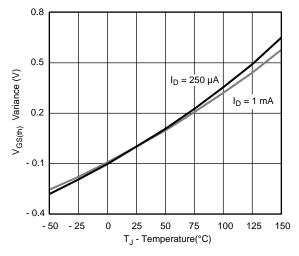
On-Resistance vs. Gate-to-Source Voltage

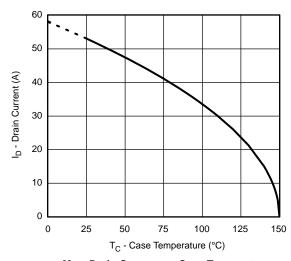


Drain-Source Breakdown Voltage vs. Junction Temperature

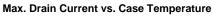


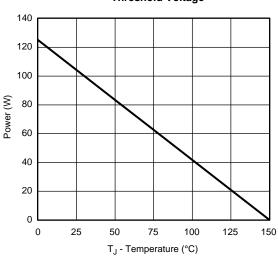
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

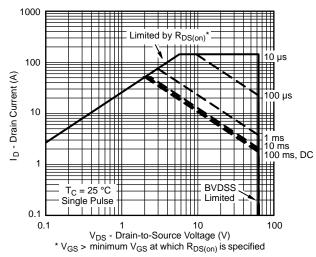




Threshold Voltage

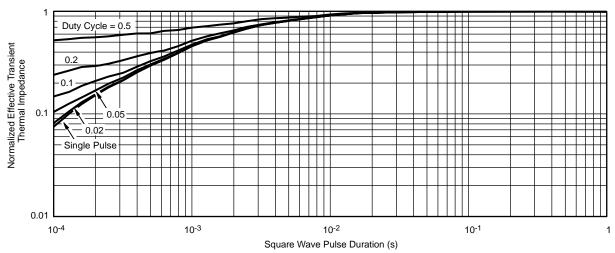






Power Derating, Junction-to-Case

Safe Operating Area, Junction-to-Case

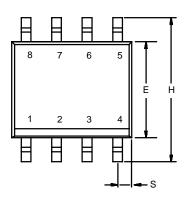


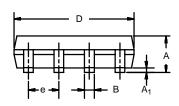
Normalized Thermal Transient Impedance, Junction-to-Case

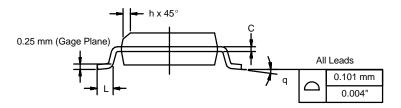
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SOIC (NARROW): 8-LEADJEDEC Part Number: MS-012







	MILLIM	IETERS	INC	NCHES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
FCN: C-06527-Rev I 11-Sen-06					

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

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